ANNEXE A1

MC14504B

Hex Level Shifter for TTL to CMOS or CMOS to CMOS

The MC14504B is a hex non–inverting level shifter using CMOS technology. The level shifter will shift a TTL signal to CMOS logic levels for any CMOS supply voltage between 5 and 15 volts. A control input also allows interface from CMOS to CMOS at one logic level to another logic level: Either up or down level translating is accomplished by selection of power supply levels V_{DD} and V_{CC}. The V_{CC} level sets the input signal levels while V_{DD} selects the output voltage levels.

- UP Translates from a Low to a High Voltage or DOWN Translates from a High to a Low Voltage
- Input Threshold Can Be Shifted for TTL Compatibility
- No Sequencing Required on Power Supplies or Inputs for Power Up or Power Down
- 3 to 18 Vdc Operation for V_{DD} and V_{CC}
- Diode Protected Inputs to V_{SS}
- Capable of Driving Two Low–Power TTL Loads or One Low–Power Schottky TTL Load Over the Rated Temperature Range

MAXIMUM RATINGS (Voltages Referenced to V_{SS}) (Note 2.)

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage Range	–0.5 to +18.0	V
V_{DD}	DC Supply Voltage Range	–0.5 to +18.0	V
V_{in}	Input Voltage Range (DC or Transient)	–0.5 to +18.0	V
V_{out}	Output Voltage Range (DC or Transient)	–0.5 to V_{DD} + 0.5	V
I_{in}, I_{out}	Input or Output Current (DC or Transient) per Pin	±10	mA
P_D	Power Dissipation, per Package (Note 3.)	500	mW
T_A	Ambient Temperature Range	–55 to +125	°C
T_{stg}	Storage Temperature Range	–65 to +150	°C
T_L	Lead Temperature (8–Second Soldering)	260	°C

2. Maximum Ratings are those values beyond which damage to the device may occur.
3. Temperature Derating:
   Plastic "P and D/DW" Packages: – 7.0 mW/°C From 65°C To 125°C

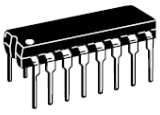
This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \le (V_{in}$ or $V_{out}) \le V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

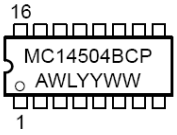
ON Semiconductor

http://onsemi.com

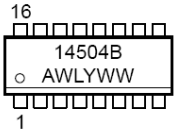
MARKING DIAGRAMS



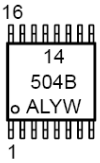
PDIP–16
P SUFFIX
CASE 648



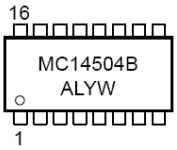
SOIC–16
D SUFFIX
CASE 751B



TSSOP–16
DT SUFFIX
CASE 948F



SOEIAJ–16
F SUFFIX
CASE 966



A = Assembly Location
WL, L = Wafer Lot
YY, Y = Year
WW, W = Work Week

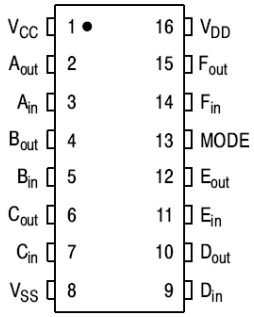
ORDERING INFORMATION

Device	Package	Shipping
MC14504BCP	PDIP–16	2000/Box
MC14504BD	SOIC–16	48/Rail
MC14504BDR2	SOIC–16	2500/Tape & Reel
MC14504BDT	TSSOP–16	96/Rail
MC14504BF	SOEIAJ–16	See Note 1.
MC14504BFEL	SOEIAJ–16	See Note 1.

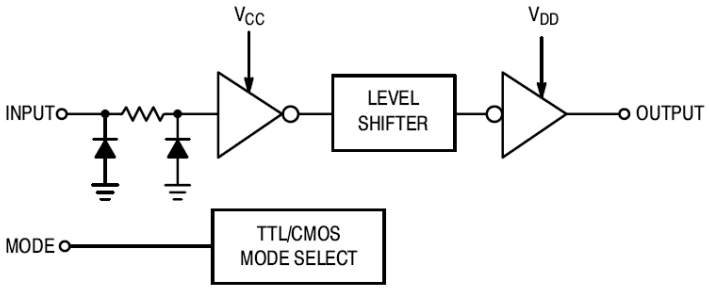
1. For ordering information on the EIAJ version of the SOIC packages, please contact your local ON Semiconductor representative.

MC14504B

PIN ASSIGNMENT



LOGIC DIAGRAM



Mode Select	Input Logic Levels	Output Logic Levels
1 (V_{CC})	TTL	CMOS
0 (V_{SS})	CMOS	CMOS

1/6 of package shown.

ANNEXE A2

CD4049UB, CD4050B

TEXAS INSTRUMENTS

Data sheet acquired from Harris Semiconductor
SCHS046A

August 1998 - Revised May 1999

CMOS Hex Buffer/Converters

The CD4049UB and CD4050B devices are inverting and non-inverting hex buffers, respectively, and feature logic-level conversion using only one supply voltage (V_{CC}). The input-signal high level (V_{IH}) can exceed the V_{CC} supply voltage when these devices are used for logic-level conversions. These devices are intended for use as CMOS to DTL/TTL converters and can drive directly two DTL/TTL loads. (V_{CC} = 5V, $V_{OL} \leq 0.4V$, and $I_{OL} \geq 3.3mA$.)

The CD4049UB and CD4050B are designated as replacements for CD4009UB and CD4010B, respectively. Because the CD4049UB and CD4050B require only one power supply, they are preferred over the CD4009UB and CD4010B and should be used in place of the CD4009UB and CD4010B in all inverter, current driver, or logic-level conversion applications. In these applications the CD4049UB and CD4050B are pin compatible with the CD4009UB and CD4010B respectively, and can be substituted for these devices in existing as well as in new designs. Terminal No. 16 is not connected internally on the CD4049UB or CD4050B, therefore, connection to this terminal is of no consequence to circuit operation. For applications not requiring high sink-current or voltage conversion, the CD4069UB Hex Inverter is recommended.

Features

- CD4049UB Inverting
- CD4050B Non-Inverting
- High Sink Current for Driving 2 TTL Loads
- High-To-Low Level Logic Conversion
- 100% Tested for Quiescent Current at 20V
- Maximum Input Current of 1µA at 18V Over Full Package Temperature Range; 100nA at 18V and 25°C
- 5V, 10V and 15V Parametric Ratings

Applications

- CMOS to DTL/TTL Hex Converter
- CMOS Current “Sink” or “Source” Driver
- CMOS High-To-Low Logic Level Converter

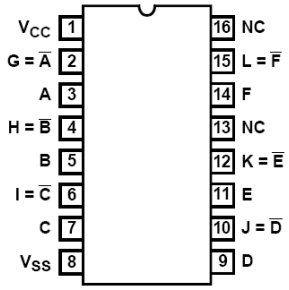
Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
CD4049UBE	-55 to 125	16 Ld PDIP	E16.3
CD4050BE	-55 to 125	16 Ld PDIP	E16.3
CD4049UBF	-55 to 125	16 Ld CERDIP	F16.3
CD4050BF	-55 to 125	16 Ld CERDIP	F16.3
CD4050BM	-55 to 125	16 Ld SOIC	M16.3

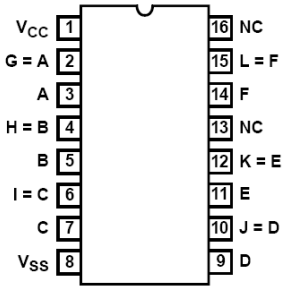
NOTE: Wafer and die for this part number is available which meets all electrical specifications. Please contact your local sales office or customer service for ordering information.

Pinouts

CD4049UB (PDIP, CERDIP)
TOP VIEW



CD4050B (PDIP, CERDIP, SOIC)
TOP VIEW



CD4049UB, CD4050B

Absolute Maximum Ratings

Supply Voltage (V+ to V-) . . . . . -0.5V to 20V
DC Input Current, Any One Input . . . . . ±10mA

Operating Conditions

Temperature Range . . . . . -55°C to 125°C

Thermal Information

Thermal Resistance (Typical, Note 1)	θ_{JA} (°C/W)	θ_{JC} (°C/W)
PDIP Package	90	N/A
CERDIP Package	130	55
SOIC Package	100	N/A

Maximum Junction Temperature (Plastic Package) . . . . . 150°C
Maximum Storage Temperature Range . . . . . -65°C to 150°C
Maximum Lead Temperature (Soldering 10s) . . . . . 265°C
(SOIC - Lead Tips Only)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

PARAMETER	TEST CONDITIONS			LIMITS AT INDICATED TEMPERATURE (°C)							UNITS
								25			
	V_O (V)	V_{IN} (V)	V_{CC} (V)	-55	-40	85	125	MIN	TYP	MAX	
Quiescent Device Current I_{DD} (Max)	-	0,5	5	1	1	30	30	-	0.02	1	µA
	-	0,10	10	2	2	60	60	-	0.02	2	µA
	-	0,15	15	4	4	120	120	-	0.02	4	µA
	-	0,20	20	20	20	600	600	-	0.04	20	µA
Output Low (Sink) Current I_{OL} (Min)	0.4	0,5	4.5	3.3	3.1	2.1	1.8	2.6	5.2	-	mA
	0.4	0,5	5	4	3.8	2.9	2.4	3.2	6.4	-	mA
	0.5	0,10	10	10	9.6	6.6	5.6	8	16	-	mA
	1.5	0,15	15	26	25	20	18	24	48	-	mA
Output High (Source) Current I_{OH} (Min)	4.6	0,5	5	-0.81	-0.73	-0.58	-0.48	-0.65	-1.2	-	mA
	2.5	0,5	5	-2.6	-2.4	-1.9	-1.55	-2.1	-3.9	-	mA
	9.5	0,10	10	-2.0	-1.8	-1.35	-1.18	-1.65	-3.0	-	mA
	13.5	0,15	15	-5.2	-4.8	-3.5	-3.1	-4.3	-8.0	-	mA
Out Voltage Low Level V_{OL} (Max)	-	0,5	5	0.05	0.05	0.05	0.05	-	0	0.05	V
	-	0,10	10	0.05	0.05	0.05	0.05	-	0	0.05	V
	-	0,15	5	0.05	0.05	0.05	0.05	-	0	0.05	V
Output Voltage High Level V_{OH} (Min)	-	0,5	5	4.95	4.95	4.95	4.95	4.95	5	-	V
	-	0,10	10	9.95	9.95	9.95	9.95	9.95	10	-	V
	-	0,15	15	14.95	14.95	14.95	14.95	14.95	15	-	V
Input Low Voltage, V_{IL} (Max) CD4049UB	4.5	-	5	1	1	1	1	-	-	1	V
	9	-	10	2	2	2	2	-	-	2	V
	13.5	-	15	2.5	2.5	2.5	2.5	-	-	2.5	V
Input Low Voltage, V_{IL} (Max) CD4050B	0.5	-	5	1.5	1.5	1.5	1.5	-	-	1.5	V
	1	-	10	3	3	3	3	-	-	3	V
	1.5	-	15	4	4	4	4	-	-	4	V
Input High Voltage, V_{IH} Min CD4049UB	0.5	-	5	4	4	4	4	4	-	-	V
	1	-	10	8	8	8	8	8	-	-	V
	1.5	-	15	12.5	12.5	12.5	12.5	12.5	-	-	V

ANNEXE B1

Data Sheet **AD633**

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

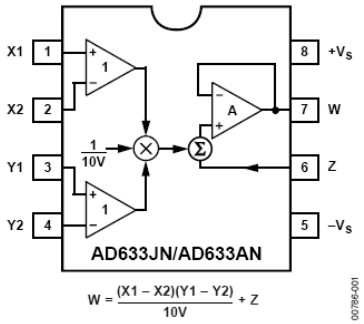


Figure 2. 8-Lead PDIP

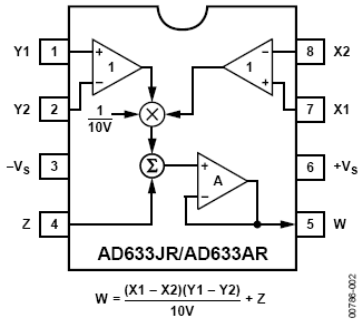


Figure 3. 8-Lead SOIC

Table 4. 8-Lead PDIP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	X1	X Multiplicand Noninverting Input
2	X2	X Multiplicand Inverting Input
3	Y1	Y Multiplicand Noninverting Input
4	Y2	Y Multiplicand Inverting Input
5	$-V_S$	Negative Supply Rail
6	Z	Summing Input
7	W	Product Output
8	$+V_S$	Positive Supply Rail

Table 5. 8-Lead SOIC Pin Function Descriptions

Pin No.	Mnemonic	Description
1	Y1	Y Multiplicand Noninverting Input
2	Y2	Y Multiplicand Inverting Input
3	$-V_S$	Negative Supply Rail
4	Z	Summing Input
5	W	Product Output
6	$+V_S$	Positive Supply Rail
7	X1	X Multiplicand Noninverting Input
8	X2	X Multiplicand Inverting Input

Data Sheet **AD633**

SPECIFICATIONS

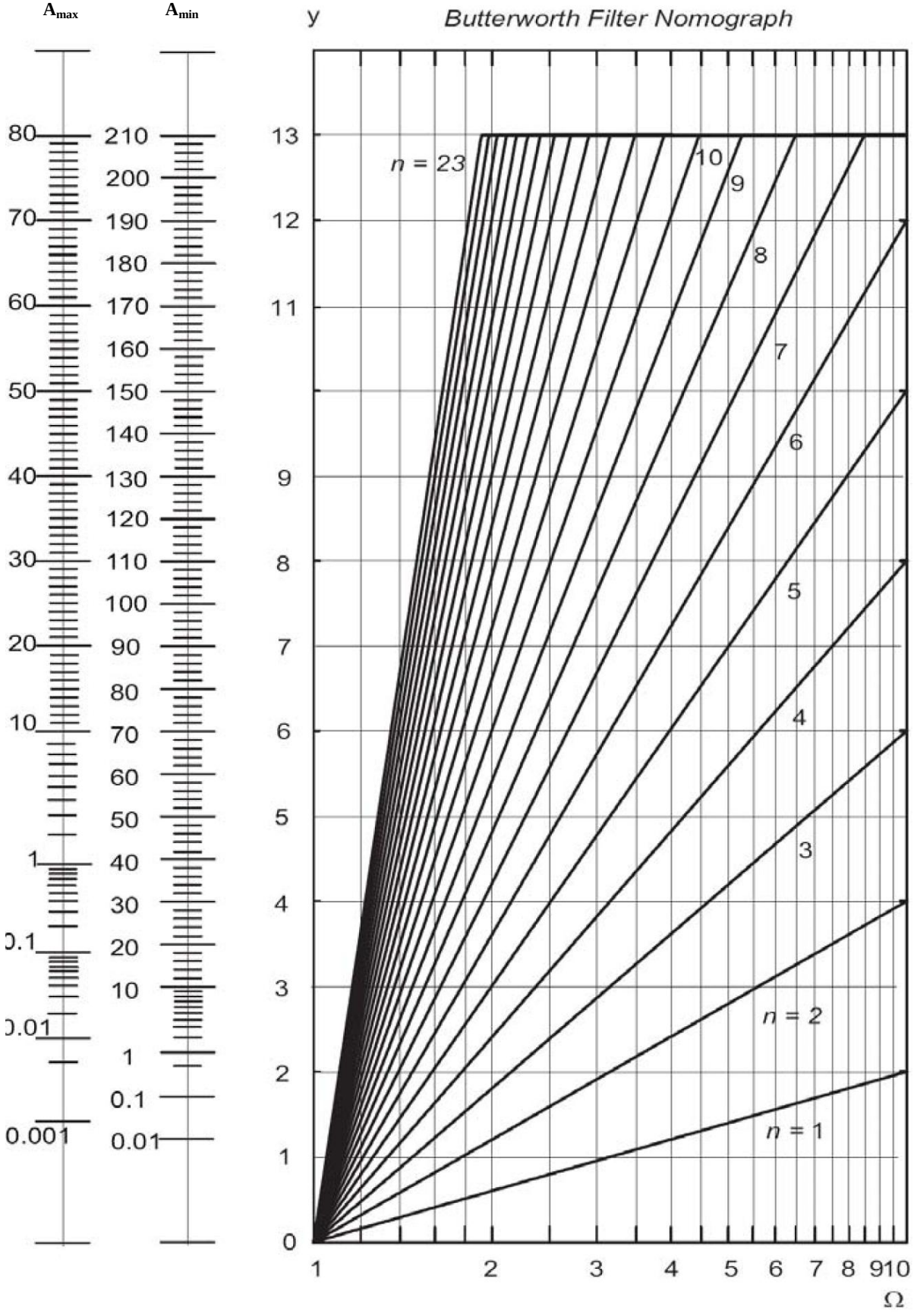
T_A = 25°C, V_S = ±15 V, $R_L \geq 2$ kΩ.

Table 1.

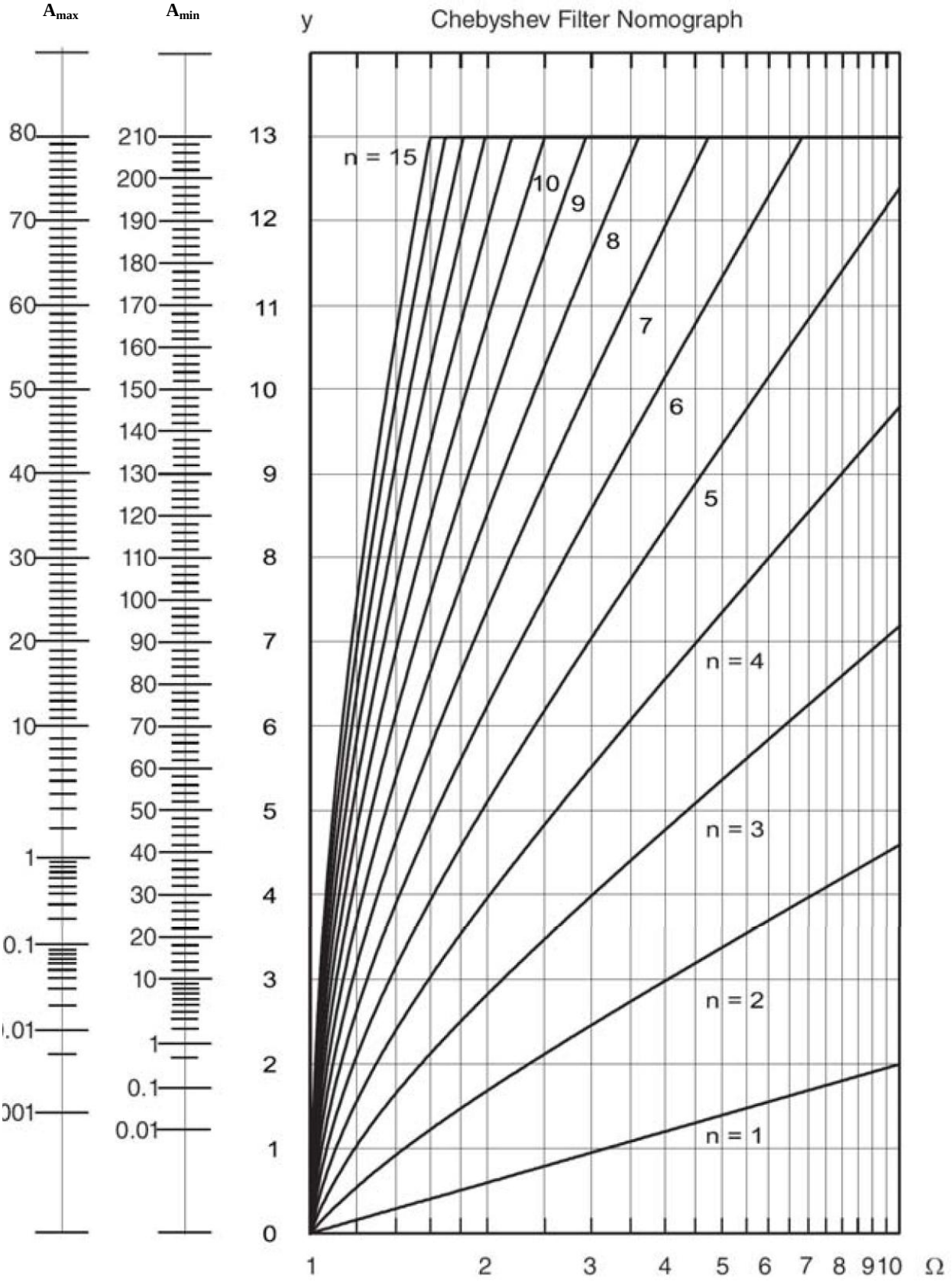
Parameter	Conditions	AD633J, AD633A Min	Typ	Max	Unit
TRANSFER FUNCTION			$W = \frac{(X1 - X2)(Y1 - Y2)}{10\ \text{V}} + Z$		
MULTIPLIER PERFORMANCE					
Total Error	−10 V ≤ X, Y ≤ +10 V		±1	±2[1]	% full scale
T_{MIN} to T_{MAX}			±3		% full scale
Scale Voltage Error	SF = 10.00 V nominal		±0.25%		% full scale
Supply Rejection	V_S = ±14 V to ±16 V		±0.01		% full scale
Nonlinearity, X	X = ±10 V, Y = +10 V		±0.4	±1[1]	% full scale
Nonlinearity, Y	Y = ±10 V, X = +10 V		±0.1	±0.4[1]	% full scale
X Feedthrough	Y nulled, X = ±10 V		±0.3	±1[1]	% full scale
Y Feedthrough	X nulled, Y = ±10 V		±0.1	±0.4[1]	% full scale
Output Offset Voltage			±5	±50[1]	mV
DYNAMICS					
Small Signal Bandwidth	V_O = 0.1 V rms		1		MHz
Slew Rate	V_O = 20 V p-p		20		V/µs
Settling Time to 1%	ΔV_O = 20 V		2		µs
OUTPUT NOISE					
Spectral Density			0.8		µV/√Hz
Wideband Noise	f = 10 Hz to 5 MHz		1		mV rms
	f = 10 Hz to 10 kHz		90		µV rms
OUTPUT					
Output Voltage Swing		±11[1]			V
Short Circuit Current	R_L = 0 Ω		30	40[1]	mA
INPUT AMPLIFIERS					
Signal Voltage Range	Differential	±10[1]			V
	Common mode	±10[1]			V
Offset Voltage (X, Y)			±5	±30[1]	mV
CMRR (X, Y)	V_{CM} = ±10 V, f = 50 Hz	60[1]	80		dB
Bias Current (X, Y, Z)			0.8	2.0[1]	µA
Differential Resistance			10		MΩ
POWER SUPPLY					
Supply Voltage					
Rated Performance			±15		V
Operating Range		±8[1]		±18[1]	V
Supply Current	Quiescent		4	6[1]	mA

[1] This specification was tested on all production units at electrical test. Results from those tests are used to calculate outgoing quality levels. All minimum and maximum specifications are guaranteed; however, only this specification was tested on all production units.

ANNEXE B2


A_{max}
A_{min}
y
Butterworth Filter Nomograph
n = 23
10
9
8
7
6
5
4
3
n = 2
n = 1
Ω

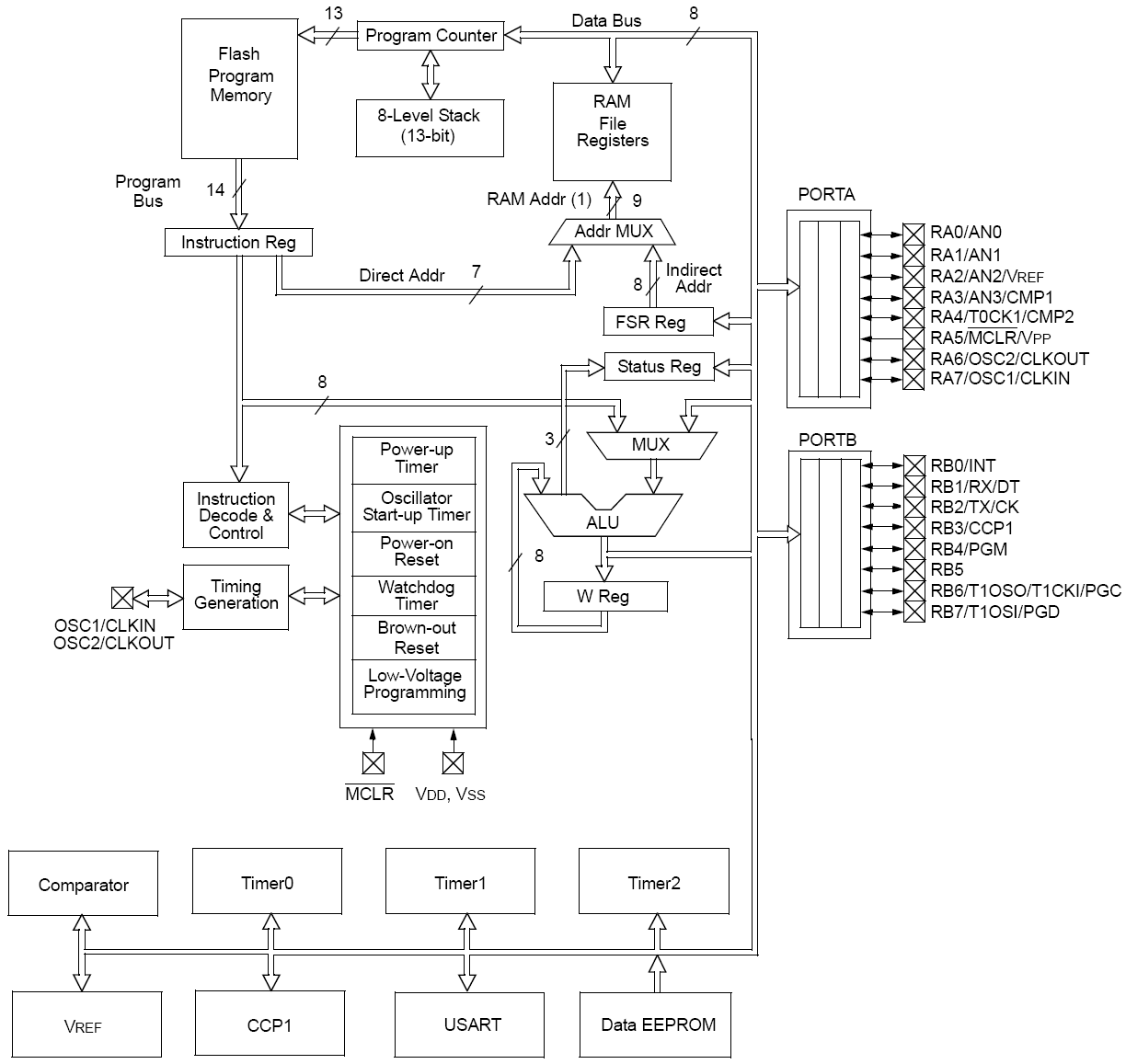
ANNEXE B3


Chebyshev Filter Nomograph
y
A_{max}
A_{min}
n = 15
10
9
8
7
6
5
n = 4
n = 3
n = 2
n = 1
Ω

ANNEXE C1

PIC16F627A/628A/648A

FIGURE 3-1: BLOCK DIAGRAM



Note 1: Higher order bits are from the Status register.

PIC16F627A/628A/648A

4.2.2.1 Status Register

The Status register, shown in Register 4-1, contains the arithmetic status of the ALU; the Reset status and the bank select bits for data memory (SRAM).

The Status register can be the destination for any instruction, like any other register. If the Status register is the destination for an instruction that affects the Z, DC or C bits, then the write to these three bits is disabled. These bits are set or cleared according to the device logic. Furthermore, the $\overline{TO}$ and $\overline{PD}$ bits are non-writable. Therefore, the result of an instruction with the Status register as destination may be different than intended.

For example, `CLRF STATUS` will clear the upper-three bits and set the Z bit. This leaves the Status register as `"000uu1uu"` (where `u` = unchanged).

It is recommended, therefore, that only `BCF`, `BSF`, `SWAPF` and `MOVWF` instructions are used to alter the Status register because these instructions do not affect any Status bit. For other instructions, not affecting any Status bits, see the "Instruction Set Summary".

Note:	The C and DC bits operate as a $\overline{Borrow}$ and $\overline{Digit\ Borrow}$ out bit, respectively, in subtraction. See the `SUBLW` and `SUBWF` instructions for examples.

REGISTER 4-1: STATUS – STATUS REGISTER (ADDRESS: 03h, 83h, 103h, 183h)

R/W-0	R/W-0	R/W-0	R-1	R-1	R/W-x	R/W-x	R/W-x
IRP	RP1	RP0	$\overline{TO}$	$\overline{PD}$	Z	DC	C
bit 7							bit 0

bit 7 **IRP**: Register Bank Select bit (used for indirect addressing)
`1` = Bank 2, 3 (100h-1FFh)
`0` = Bank 0, 1 (00h-FFh)

bit 6-5 **RP<1:0>**: Register Bank Select bits (used for direct addressing)
`00` = Bank 0 (00h-7Fh)
`01` = Bank 1 (80h-FFh)
`10` = Bank 2 (100h-17Fh)
`11` = Bank 3 (180h-1FFh)

bit 4 **$\overline{TO}$**: Time Out bit
`1` = After power-up, `CLRWDT` instruction or `SLEEP` instruction
`0` = A WDT time out occurred

bit 3 **$\overline{PD}$**: Power-down bit
`1` = After power-up or by the `CLRWDT` instruction
`0` = By execution of the `SLEEP` instruction

bit 2 **Z**: Zero bit
`1` = The result of an arithmetic or logic operation is zero
`0` = The result of an arithmetic or logic operation is not zero

bit 1 **DC**: Digit Carry/$\overline{Borrow}$ bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions) (for $\overline{Borrow}$ the polarity is reversed)
`1` = A carry-out from the 4th low order bit of the result occurred
`0` = No carry-out from the 4th low order bit of the result

bit 0 **C**: Carry/$\overline{Borrow}$ bit (`ADDWF`, `ADDLW`, `SUBLW`, `SUBWF` instructions)
`1` = A carry-out from the Most Significant bit of the result occurred
`0` = No carry-out from the Most Significant bit of the result occurred

Note: For $\overline{Borrow}$, the polarity is reversed. A subtraction is executed by adding the two's complement of the second operand. For rotate (`RRF`, `RLF`) instructions, this bit is loaded with either the high or low order bit of the source register.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

PIC16F627A/628A/648A

4.2.2.2 OPTION Register

The Option register is a readable and writable register, which contains various control bits to configure the TMR0/WDT prescaler, the external RB0/INT interrupt, TMR0 and the weak pull-ups on PORTB.

Note:	To achieve a 1:1 prescaler assignment for TMR0, assign the prescaler to the WDT (PSA = 1). See **Section 6.3.1 "Switching Prescaler Assignment"**.

REGISTER 4-2: OPTION_REG – OPTION REGISTER (ADDRESS: 81h, 181h)

R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1
$\overline{\text{RBPU}}$	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0
bit 7							bit 0

bit 7 **$\overline{\text{RBPU}}$**: PORTB Pull-up Enable bit
1 = PORTB pull-ups are disabled
0 = PORTB pull-ups are enabled by individual port latch values

bit 6 **INTEDG**: Interrupt Edge Select bit
1 = Interrupt on rising edge of RB0/INT pin
0 = Interrupt on falling edge of RB0/INT pin

bit 5 **T0CS**: TMR0 Clock Source Select bit
1 = Transition on RA4/T0CKI/CMP2 pin
0 = Internal instruction cycle clock (CLKOUT)

bit 4 **T0SE**: TMR0 Source Edge Select bit
1 = Increment on high-to-low transition on RA4/T0CKI/CMP2 pin
0 = Increment on low-to-high transition on RA4/T0CKI/CMP2 pin

bit 3 **PSA**: Prescaler Assignment bit
1 = Prescaler is assigned to the WDT
0 = Prescaler is assigned to the Timer0 module

bit 2-0 **PS<2:0>**: Prescaler Rate Select bits

Bit Value	TMR0 Rate	WDT Rate
000	1 : 2	1 : 1
001	1 : 4	1 : 2
010	1 : 8	1 : 4
011	1 : 16	1 : 8
100	1 : 32	1 : 16
101	1 : 64	1 : 32
110	1 : 128	1 : 64
111	1 : 256	1 : 128

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

PIC16F627A/628A/648A

4.2.2.3 INTCON Register

The INTCON register is a readable and writable register, which contains the various enable and flag bits for all interrupt sources except the comparator module. See **Section 4.2.2.4 "PIE1 Register"** and **Section 4.2.2.5 "PIR1 Register"** for a description of the comparator enable and flag bits.

Note:	Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

REGISTER 4-3: INTCON – INTERRUPT CONTROL REGISTER (ADDRESS: 0Bh, 8Bh, 10Bh, 18Bh)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-x
GIE	PEIE	T0IE	INTE	RBIE	T0IF	INTF	RBIF
bit 7							bit 0

bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all un-masked interrupts
0 = Disables all interrupts

bit 6 **PEIE**: Peripheral Interrupt Enable bit
1 = Enables all un-masked peripheral interrupts
0 = Disables all peripheral interrupts

bit 5 **T0IE**: TMR0 Overflow Interrupt Enable bit
1 = Enables the TMR0 interrupt
0 = Disables the TMR0 interrupt

bit 4 **INTE**: RB0/INT External Interrupt Enable bit
1 = Enables the RB0/INT external interrupt
0 = Disables the RB0/INT external interrupt

bit 3 **RBIE**: RB Port Change Interrupt Enable bit
1 = Enables the RB port change interrupt
0 = Disables the RB port change interrupt

bit 2 **T0IF**: TMR0 Overflow Interrupt Flag bit
1 = TMR0 register has overflowed (must be cleared in software)
0 = TMR0 register did not overflow

bit 1 **INTF**: RB0/INT External Interrupt Flag bit
1 = The RB0/INT external interrupt occurred (must be cleared in software)
0 = The RB0/INT external interrupt did not occur

bit 0 **RBIF**: RB Port Change Interrupt Flag bit
1 = When at least one of the RB<7:4> pins changes state (must be cleared in software)
0 = None of the RB<7:4> pins have changed state

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

PIC16F627A/628A/648A

4.2.2.5 PIR1 Register

This register contains interrupt flag bits.

Note:	Interrupt flag bits get set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>). User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 4-5: PIR1 – PERIPHERAL INTERRUPT REGISTER 1 (ADDRESS: 0Ch)

R/W-0	R/W-0	R-0	R-0	U-0	R/W-0	R/W-0	R/W-0
EEIF	CMIF	RCIF	TXIF	—	CCP1IF	TMR2IF	TMR1IF
bit 7							bit 0

bit 7 **EEIF:** EEPROM Write Operation Interrupt Flag bit
1 = The write operation completed (must be cleared in software)
0 = The write operation has not completed or has not been started

bit 6 **CMIF**: Comparator Interrupt Flag bit
1 = Comparator output has changed
0 = Comparator output has not changed

bit 5 **RCIF**: USART Receive Interrupt Flag bit
1 = The USART receive buffer is full
0 = The USART receive buffer is empty

bit 4 **TXIF**: USART Transmit Interrupt Flag bit
1 = The USART transmit buffer is empty
0 = The USART transmit buffer is full

bit 3 **Unimplemented**: Read as '0'

bit 2 **CCP1IF**: CCP1 Interrupt Flag bit
Capture Mode
1 = A TMR1 register capture occurred (must be cleared in software)
0 = No TMR1 register capture occurred
Compare Mode
1 = A TMR1 register compare match occurred (must be cleared in software)
0 = No TMR1 register compare match occurred
PWM Mode
Unused in this mode

bit 1 **TMR2IF**: TMR2 to PR2 Match Interrupt Flag bit
1 = TMR2 to PR2 match occurred (must be cleared in software)
0 = No TMR2 to PR2 match occurred

bit 0 **TMR1IF**: TMR1 Overflow Interrupt Flag bit
1 = TMR1 register overflowed (must be cleared in software)
0 = TMR1 register did not overflow

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

PIC16F627A/628A/648A

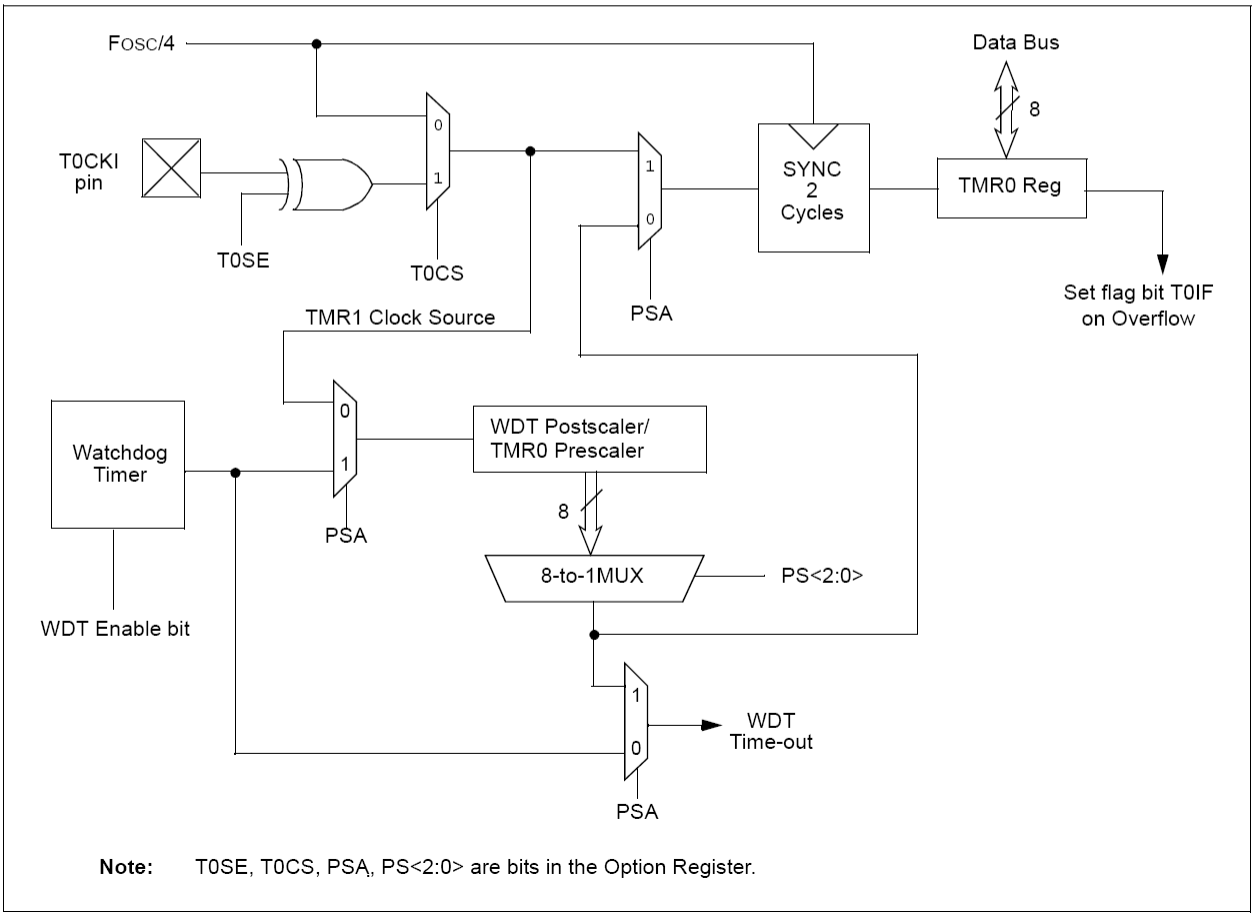
6.3 Timer0 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer. A prescaler assignment for the Timer0 module means that there is no postscaler for the Watchdog Timer, and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., `CLRF 1, MOVWF 1, BSF 1, x....etc.`) will clear the prescaler. When assigned to WDT, a `CLRWDT` instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

FIGURE 6-1: BLOCK DIAGRAM OF THE TIMER0/WDT



Note: T0SE, T0CS, PSA, PS<2:0> are bits in the Option Register.

PIC16F627A/628A/648A

7.0 TIMER1 MODULE

The Timer1 module is a 16-bit timer/counter consisting of two 8-bit registers (TMR1H and TMR1L) which are readable and writable. The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 Interrupt, if enabled, is generated on overflow of the TMR1 register pair which latches the interrupt flag bit TMR1IF (PIR1<0>). This interrupt can be enabled/disabled by setting/clearing the Timer1 interrupt enable bit TMR1IE (PIE1<0>).

Timer1 can operate in one of two modes:

- As a timer
- As a counter

The Operating mode is determined by the clock select bit, TMR1CS (T1CON<1>).

In Timer mode, the TMR1 register pair value increments every instruction cycle. In Counter mode, it increments on every rising edge of the external clock input.

Timer1 can be enabled/disabled by setting/clearing control bit TMR1ON (T1CON<0>).

Timer1 also has an internal "Reset input". This Reset can be generated by the CCP module (**Section 9.0 "Capture/Compare/PWM (CCP) Module"**). Register 7-1 shows the Timer1 control register.

For the PIC16F627A/628A/648A, when the Timer1 oscillator is enabled (T1OSCEN is set), the RB7/T1OSI/PGD and RB6/T1OSO/T1CKI/PGC pins become inputs. That is, the TRISB<7:6> value is ignored.

REGISTER 7-1: T1CON – TIMER1 CONTROL REGISTER (ADDRESS: 10h)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	T1CKPS1	T1CKPS0	T1OSCEN	$\overline{\text{T1SYNC}}$	TMR1CS	TMR1ON
bit 7							bit 0

bit 7-6 **Unimplemented**: Read as '0'

bit 5-4 **T1CKPS<1:0>**: Timer1 Input Clock Prescale Select bits
11 = 1:8 Prescale value
10 = 1:4 Prescale value
01 = 1:2 Prescale value
00 = 1:1 Prescale value

bit 3 **T1OSCEN**: Timer1 Oscillator Enable Control bit
1 = Oscillator is enabled
0 = Oscillator is shut off(1)

bit 2 **$\overline{\text{T1SYNC}}$**: Timer1 External Clock Input Synchronization Control bit
TMR1CS = 1
1 = Do not synchronize external clock input
0 = Synchronize external clock input
TMR1CS = 0
This bit is ignored. Timer1 uses the internal clock when TMR1CS = 0.

bit 1 **TMR1CS**: Timer1 Clock Source Select bit
1 = External clock from pin RB6/T1OSO/T1CKI/PGC (on the rising edge)
0 = Internal clock (FOSC/4)

bit 0 **TMR1ON**: Timer1 On bit
1 = Enables Timer1
0 = Stops Timer1

Note 1: The oscillator inverter and feedback resistor are turned off to eliminate power drain.

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

7.1 Timer1 Operation in Timer Mode

Timer mode is selected by clearing the TMR1CS (T1CON<1>) bit. In this mode, the input clock to the timer is FOSC/4. The synchronize control bit $\overline{\text{T1SYNC}}$ (T1CON<2>) has no effect since the internal clock is always in sync.

7.2 Timer1 Operation in Synchronized Counter Mode

Counter mode is selected by setting bit TMR1CS. In this mode, the TMR1 register pair value increments on every rising edge of clock input on pin RB7/T1OSI/PGD when bit T1OSCEN is set or pin RB6/T1OSO/T1CKI/PGC when bit T1OSCEN is cleared.

If $\overline{\text{T1SYNC}}$ is cleared, then the external clock input is synchronized with internal phase clocks. The synchronization is done after the prescaler stage. The prescaler stage is an asynchronous ripple-counter.

In this configuration, during Sleep mode, the TMR1 register pair value will not increment even if the external clock is present, since the synchronization circuit is shut off. The prescaler however will continue to increment.

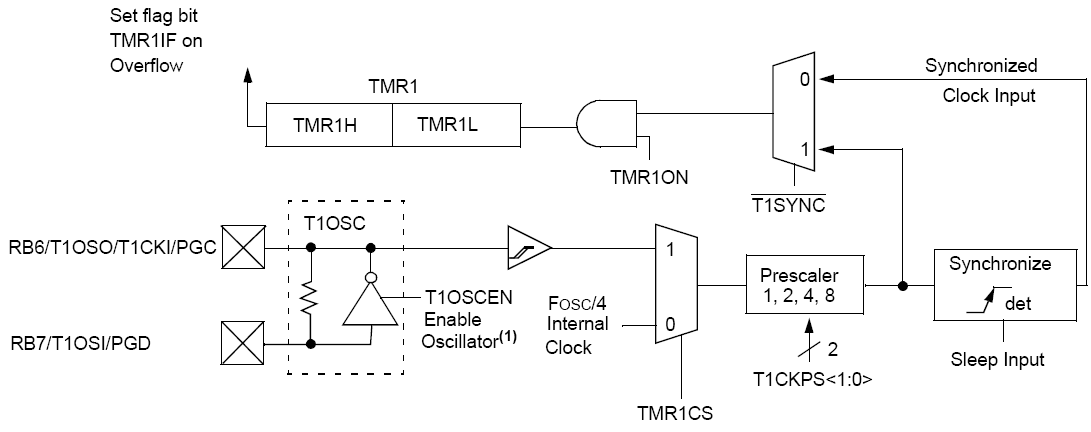
7.2.1 EXTERNAL CLOCK INPUT TIMING FOR SYNCHRONIZED COUNTER MODE

When an external clock input is used for Timer1 in Synchronized Counter mode, it must meet certain requirements. The external clock requirement is due to internal phase clock (TOSC) synchronization. Also, there is a delay in the actual incrementing of the TMR1 register pair value after synchronization.

When the prescaler is 1:1, the external clock input is the same as the prescaler output. The synchronization of T1CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks. Therefore, it is necessary for T1CKI to be high for at least 2 TOSC (and a small RC delay of 20 ns) and low for at least 2 TOSC (and a small RC delay of 20 ns). Refer to Table 17-8 in the Electrical Specifications Section, timing parameters 45, 46 and 47.

When a prescaler other than 1:1 is used, the external clock input is divided by the asynchronous ripple-counter type prescaler so that the prescaler output is symmetrical. In order for the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T1CKI to have a period of at least 4 TOSC (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T1CKI high and low time is that they do not violate the minimum pulse width requirements of 10 ns). Refer to the appropriate electrical specifications in Table 17-8, parameters 45, 46 and 47.

FIGURE 7-1: TIMER1 BLOCK DIAGRAM



Note 1: When the T1OSCEN bit is cleared, the inverter and feedback resistor are turned off. This eliminates power drain.

PIC16F627A/628A/648A

9.0 CAPTURE/COMPARE/PWM (CCP) MODULE

The CCP (Capture/Compare/PWM) module contains a 16-bit register which can operate as a 16-bit Capture register, as a 16-bit Compare register or as a PWM master/slave Duty Cycle register. Table 9-1 shows the timer resources of the CCP module modes.

CCP1 Module

Capture/Compare/PWM Register1 (CCPR1) is comprised of two 8-bit registers: CCPR1L (low byte) and CCPR1H (high byte). The CCP1CON register controls the operation of CCP1. All are readable and writable.

Additional information on the CCP module is available in the *"PIC® Mid-Range MCU Family Reference Manual"* (DS33023).

TABLE 9-1: CCP MODE – TIMER RESOURCE

CCP Mode	Timer Resource
Capture	Timer1
Compare	Timer1
PWM	Timer2

REGISTER 9-1: CCP1CON – CCP OPERATION REGISTER (ADDRESS: 17h)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	CCP1X	CCP1Y	CCP1M3	CCP1M2	CCP1M1	CCP1M0
bit 7							bit 0

bit 7-6 **Unimplemented**: Read as '0'

bit 5-4 **CCP1X:CCP1Y**: PWM Least Significant bits

Capture Mode
Unused

Compare Mode
Unused

PWM Mode
These bits are the two LSbs of the PWM duty cycle. The eight MSbs are found in CCPRxL.

bit 3-0 **CCP1M<3:0>**: CCPx Mode Select bits

0000 = Capture/Compare/PWM off (resets CCP1 module)
0100 = Capture mode, every falling edge
0101 = Capture mode, every rising edge
0110 = Capture mode, every 4th rising edge
0111 = Capture mode, every 16th rising edge
1000 = Compare mode, set output on match (CCP1IF bit is set)
1001 = Compare mode, clear output on match (CCP1IF bit is set)
1010 = Compare mode, generate software interrupt on match (CCP1IF bit is set, CCP1 pin is unaffected)
1011 = Compare mode, trigger special event (CCP1IF bit is set; CCP1 resets TMR1
11xx = PWM mode

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

PIC16F627A/628A/648A

9.1 Capture Mode

In Capture mode, CCPR1H:CCPR1L captures the 16-bit value of the TMR1 register when an event occurs on pin RB3/CCP1. An event is defined as:

- Every falling edge
- Every rising edge
- Every 4th rising edge
- Every 16th rising edge

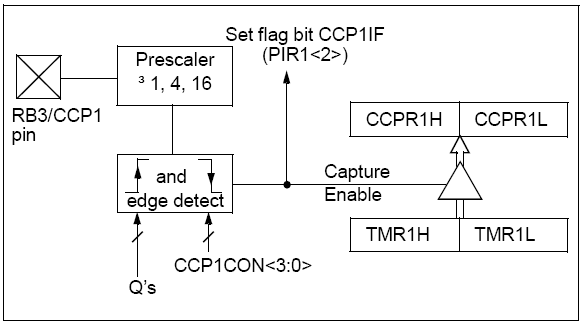
An event is selected by control bits CCP1M<3:0> (CCP1CON<3:0>). When a capture is made, the interrupt request flag bit CCP1IF (PIR1<2>) is set. It must be cleared in software. If another capture occurs before the value in register CCPR1 is read, the old captured value will be lost.

9.1.1 CCP PIN CONFIGURATION

In Capture mode, the RB3/CCP1 pin should be configured as an input by setting the TRISB<3> bit.

Note:	If the RB3/CCP1 is configured as an output, a write to the port can cause a capture condition.

FIGURE 9-1: CAPTURE MODE OPERATION BLOCK DIAGRAM



9.1.2 TIMER1 MODE SELECTION

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work.

9.1.3 SOFTWARE INTERRUPT

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep bit CCP1IE (PIE1<2>) clear to avoid false interrupts and should clear the flag bit CCP1IF following any such change in Operating mode.

9.1.4 CCP PRESCALER

There are four prescaler settings, specified by bits CCP1M<3:0>. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. This means that any Reset will clear the prescaler counter.

Switching from one capture prescaler to another may generate an interrupt. Also, the prescaler counter will not be cleared, therefore the first capture may be from a non-zero prescaler. Example 9-1 shows the recommended method for switching between capture prescalers. This example also clears the prescaler counter and will not generate the "false" interrupt.

EXAMPLE 9-1: CHANGING BETWEEN CAPTURE PRESCALERS

```
CLRF    CCP1CON     ;Turn CCP module off
MOVLW   NEW_CAPT_PS ;Load the W reg with
                    ; the new prescaler
                    ; mode value and CCP ON
MOVWF   CCP1CON     ;Load CCP1CON with this
                    ; value
```

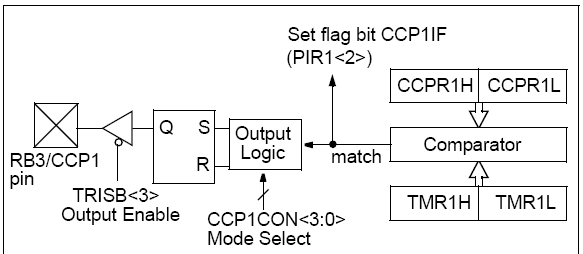
9.2 Compare Mode

In Compare mode, the 16-bit CCPR1 register value is constantly compared against the TMR1 register pair value. When a match occurs, the RB3/CCP1 pin is:

- Driven high
- Driven low
- Remains unchanged

The action on the pin is based on the value of control bits CCP1M<3:0> (CCP1CON<3:0>). At the same time, interrupt flag bit CCP1IF is set.

FIGURE 9-2: COMPARE MODE OPERATION BLOCK DIAGRAM



Note: Special event trigger will reset Timer1, but not set interrupt flag bit TMR1IF (PIR1<0>).

PIC16F627A/628A/648A

15.0 INSTRUCTION SET SUMMARY

Each PIC16F627A/628A/648A instruction is a 14-bit word divided into an OPCODE which specifies the instruction type and one or more operands which further specify the operation of the instruction. The PIC16F627A/628A/648A instruction set summary in Table 15-2 lists **byte-oriented**, **bit-oriented**, and **literal and control** operations. Table 15-1 shows the opcode field descriptions.

For **byte-oriented** instructions, 'f' represents a file register designator and 'd' represents a destination designator. The file register designator specifies which file register is to be used by the instruction.

The destination designator specifies where the result of the operation is to be placed. If 'd' is zero, the result is placed in the W register. If 'd' is one, the result is placed in the file register specified in the instruction.

For **bit-oriented** instructions, 'b' represents a bit field designator which selects the number of the bit affected by the operation, while 'f' represents the number of the file in which the bit is located.

For **literal and control** operations, 'k' represents an eight or eleven bit constant or literal value.

15.1 Read-Modify-Write Operations

Any instruction that specifies a file register as part of the instruction performs a Read-Modify-Write (R-M-W) operation. The register is read, the data is modified, and the result is stored according to either the instruction, or the destination designator 'd'. A read operation is performed on a register even if the instruction writes to that register.

For example, a "`clrf PORTB`" instruction will read PORTB, clear all the data bits, then write the result back to PORTB. This example would have the unintended result that the condition that sets the RBIF flag would be cleared for pins configured as inputs and using the PORTB interrupt-on-change feature.

TABLE 15-1: OPCODE FIELD DESCRIPTIONS

Field	Description
f	Register file address (0x00 to 0x7F)
W	Working register (accumulator)
b	Bit address within an 8-bit file register
k	Literal field, constant data or label
x	Don't care location (= 0 or 1) The assembler will generate code with x = 0. It is the recommended form of use for compatibility with all Microchip software tools.
d	Destination select; d = 0: store result in W, d = 1: store result in file register f. Default is d = 1
$\overline{TO}$	Time-out bit
$\overline{PD}$	Power-down bit

The instruction set is highly orthogonal and is grouped into three basic categories:

- **Byte-oriented** operations
- **Bit-oriented** operations
- **Literal and control** operations

All instructions are executed within one single instruction cycle, unless a conditional test is true or the program counter is changed as a result of an instruction. In this case, the execution takes two instruction cycles with the second cycle executed as a `NOP`. One instruction cycle consists of four oscillator periods. Thus, for an oscillator frequency of 4 MHz, the normal instruction execution time is 1 µs. If a conditional test is true or the program counter is changed as a result of an instruction, the instruction execution time is 2 µs.

Table 15-2 lists the instructions recognized by the MPASM™ assembler.

Figure 15-1 shows the three general formats that the instructions can have.

Note 1: Any unused opcode is reserved. Use of any reserved opcode may cause unexpected operation.

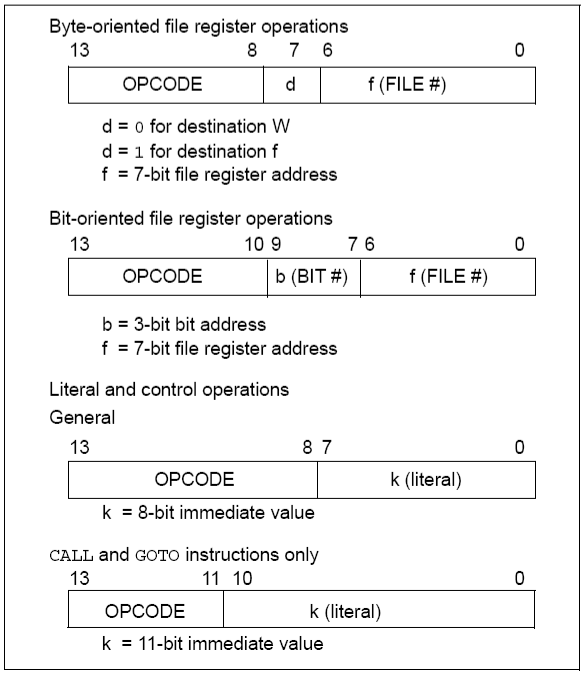
2: To maintain upward compatibility with future PIC MCU products, do not use the `OPTION` and `TRIS` instructions.

All examples use the following format to represent a hexadecimal number:

0xhh

where 'h' signifies a hexadecimal digit.

FIGURE 15-1: GENERAL FORMAT FOR INSTRUCTIONS



PIC16F627A/628A/648A

TABLE 15-2: PIC16F627A/628A/648A INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	14-Bit Opcode MSb			LSb	Status Affected	Notes
BYTE-ORIENTED FILE REGISTER OPERATIONS									
ADDWF	f, d	Add W and f	1	00	0111	dfff	ffff	C,DC,Z	1, 2
ANDWF	f, d	AND W with f	1	00	0101	dfff	ffff	Z	1, 2
CLRF	f	Clear f	1	00	0001	lfff	ffff	Z	2
CLRW	—	Clear W	1	00	0001	0xxx	xxxx	Z	
COMF	f, d	Complement f	1	00	1001	dfff	ffff	Z	1, 2
DECF	f, d	Decrement f	1	00	0011	dfff	ffff	Z	1, 2
DECFSZ	f, d	Decrement f, Skip if 0	1(2)	00	1011	dfff	ffff		1, 2, 3
INCF	f, d	Increment f	1	00	1010	dfff	ffff	Z	1, 2
INCFSZ	f, d	Increment f, Skip if 0	1(2)	00	1111	dfff	ffff		1, 2, 3
IORWF	f, d	Inclusive OR W with f	1	00	0100	dfff	ffff	Z	1, 2
MOVF	f, d	Move f	1	00	1000	dfff	ffff	Z	1, 2
MOVWF	f	Move W to f	1	00	0000	lfff	ffff		
NOP	—	No Operation	1	00	0000	0xx0	0000		
RLF	f, d	Rotate Left f through Carry	1	00	1101	dfff	ffff	C	1, 2
RRF	f, d	Rotate Right f through Carry	1	00	1100	dfff	ffff	C	1, 2
SUBWF	f, d	Subtract W from f	1	00	0010	dfff	ffff	C,DC,Z	1, 2
SWAPF	f, d	Swap nibbles in f	1	00	1110	dfff	ffff		1, 2
XORWF	f, d	Exclusive OR W with f	1	00	0110	dfff	ffff	Z	1, 2
BIT-ORIENTED FILE REGISTER OPERATIONS									
BCF	f, b	Bit Clear f	1	01	00bb	bfff	ffff		1, 2
BSF	f, b	Bit Set f	1	01	01bb	bfff	ffff		1, 2
BTFSC	f, b	Bit Test f, Skip if Clear	1(2)	01	10bb	bfff	ffff		3
BTFSS	f, b	Bit Test f, Skip if Set	1(2)	01	11bb	bfff	ffff		3
LITERAL AND CONTROL OPERATIONS									
ADDLW	k	Add literal and W	1	11	111x	kkkk	kkkk	C,DC,Z	
ANDLW	k	AND literal with W	1	11	1001	kkkk	kkkk	Z	
CALL	k	Call subroutine	2	10	0kkk	kkkk	kkkk		
CLRWDT	—	Clear Watchdog Timer	1	00	0000	0110	0100	$\overline{TO}$,$\overline{PD}$	
GOTO	k	Go to address	2	10	1kkk	kkkk	kkkk		
IORLW	k	Inclusive OR literal with W	1	11	1000	kkkk	kkkk	Z	
MOVLW	k	Move literal to W	1	11	00xx	kkkk	kkkk		
RETFIE	—	Return from interrupt	2	00	0000	0000	1001		
RETLW	k	Return with literal in W	2	11	01xx	kkkk	kkkk		
RETURN	—	Return from Subroutine	2	00	0000	0000	1000		
SLEEP	—	Go into Standby mode	1	00	0000	0110	0011	$\overline{TO}$,$\overline{PD}$	
SUBLW	k	Subtract W from literal	1	11	110x	kkkk	kkkk	C,DC,Z	
XORLW	k	Exclusive OR literal with W	1	11	1010	kkkk	kkkk	Z	

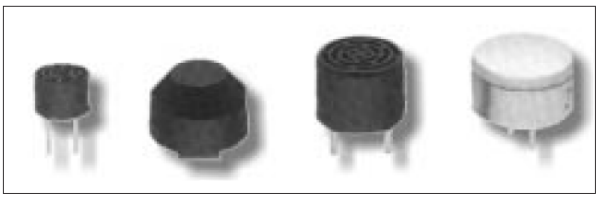
Note 1: When an I/O register is modified as a function of itself (e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

ANNEXE C2

Ultrasonic MA Series



These sensors transmit and receive ultrasonic waves, having applications in distance measurement (vehicle reversing aids etc), object detecting, security alarms and remote control

Features
1. Compact and lightweight design
2. High sensitivity and sound pressure levels
3. Low power consumption
4. High reliability
5. Open, closed waterproof and high frequency options

Types

1. Open Structure
Using the combined vibration mode of a bimorph transducer and radial core, this type exhibits high sensitivity and high sound pressure levels.
Applications : Automatic doors, Burglar Alarms, Remote control, Range finders.

2. Water Proof
This type has excellent resistance to harsh environmental conditions and can be used outdoors.
Applications : Back sonar of vehicles, Parking meters Water level meters.

3. High Frequency
Using longitudinal vibration and acoustic matching layer, this type exhibits high sensitivity in air.
Short wavelengths facilitate sharp directivity for high precision measurements.
Applications: Approach switches, distance measurements, liquid level meters, gas flow meters.

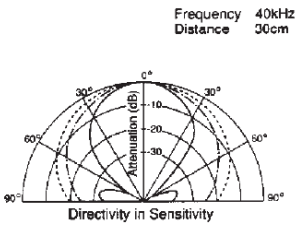
1- Open Structure Types

Order Code		MA4OS4R/S*	MA40B8R/S*	MA4OB7	MA40S5
Construction		Open structure type			
Type		Sep. Receiver & Transmitter		Combined type	
Norm. Freq.	(kHz)	40			
Sensitivity	(dB)	-63±3	-63±3	-61	-62
Sound Pressure	(dB)	120±3	120±3	-116	-111
Directivity	(deg)	100	50	40	70
Capacitance	(pF)	2550±20%	2000±20%	2000±20%	2550±20%
Op. Temp. Range	(°C)	-30 +85			
Detect. Range	(m)	0.2 - 4	0.2 - 6	0.2 - 4	0.2 - 4
Resolution	(mm)	9	9	9	9
Dimension	(mm)	9.9 Ø x7.1h	16 Ø x 12h	16 Ø x 12h	9.9Ø x 7.1h
Weight	(g)	0.7	2	2	0-7
Allowable Input (Vp-p) (Rect. wave)	V	20 (40kHz) Continuous signal	20 (40kHz) Continuous signal	100 (40kHz) Pulse width 0.4ms Interval 100ms	20 (40kHz) Continuous signal

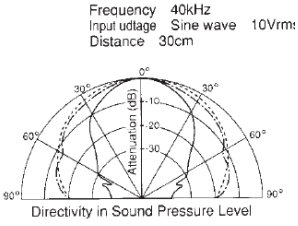
* Specify R=Receiver or S=Sender

Directivity

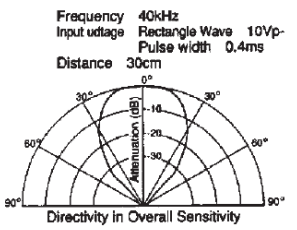
MA40B8R ——
MA40S4R – – –



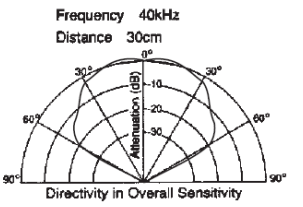
MA40B8S ——
MA40S4S – – –



MA40B7

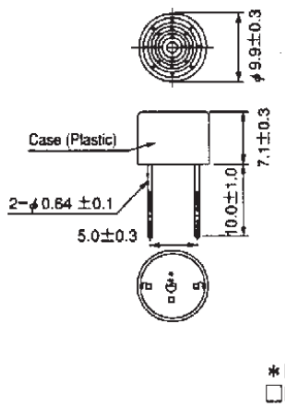


MA40S5

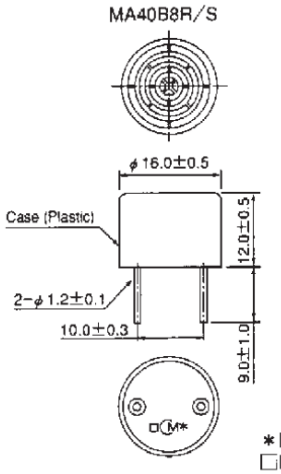


Dimensions

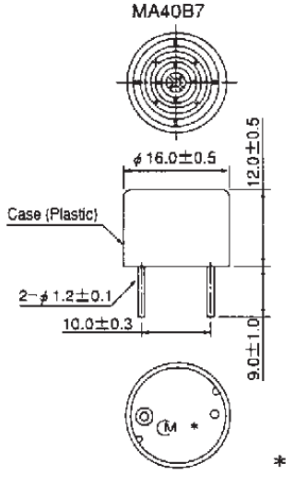
MA40S4R/S
MA40S5



MA40B8R/S



MA40B7



ANNEXE D1

FAIRCHILD SEMICONDUCTOR®

www.fairchildsemi.com

LM555
Single Timer

Features

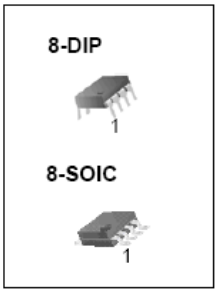
- High Current Drive Capability (200mA)
- Adjustable Duty Cycle
- Temperature Stability of 0.005%/°C
- Timing From μSec to Hours
- Turn off Time Less Than 2μSec

Applications

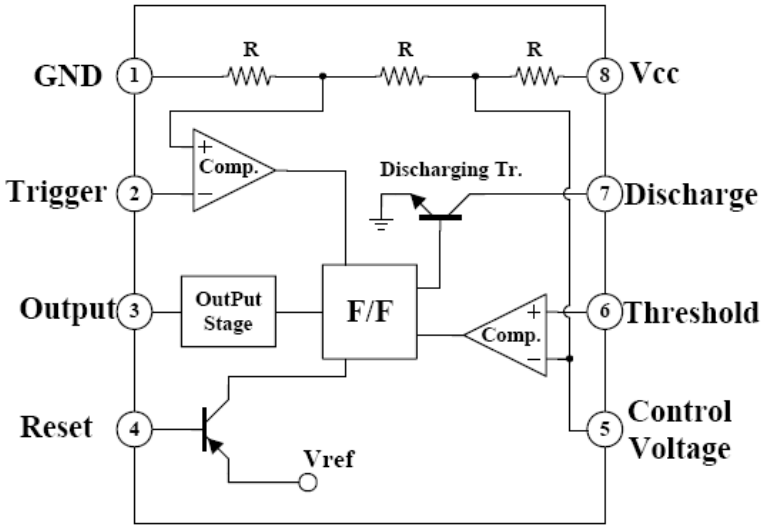
- Precision Timing
- Pulse Generation
- Time Delay Generation
- Sequential Timing

Description

The LM555 is a highly stable controller capable of producing accurate timing pulses. With a monostable operation, the time delay is controlled by one external resistor and one capacitor. With an astable operation, the frequency and duty cycle are accurately controlled by two external resistors and one capacitor.



Internal Block Diagram



LM555

Absolute Maximum Ratings (T_A = 25°C)

Parameter	Symbol	Value	Unit
Supply Voltage	V_{CC}	16	V
Lead Temperature (Soldering 10sec)	T_{LEAD}	300	°C
Power Dissipation	P_D	600	mW
Operating Temperature Range (LM555)	T_{OPR}	0 ~ +70	°C
Storage Temperature Range	T_{STG}	-65 ~ +150	°C

Electrical Characteristics

(T_A = 25°C, V_{CC} = 5 ~ 15V, unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Supply Voltage	V_{CC}	-	4.5	-	16	V
Supply Current (Low Stable) (Note1)	I_{CC}	V_{CC} = 5V, R_L = ∞	-	3	6	mA
		V_{CC} = 15V, R_L = ∞	-	7.5	15	mA
Timing Error (Monostable) Initial Accuracy (Note2) Drift with Temperature (Note4) Drift with Supply Voltage (Note4)	ACCUR Δt/ΔT Δt/ΔV_{CC}	R_A = 1kΩ to100kΩ C = 0.1μF	-	 1.0 50 0.1	 3.0 0.5	 % ppm/°C %/V
Timing Error (Astable) Intial Accuracy (Note2) Drift with Temperature (Note4) Drift with Supply Voltage (Note4)	ACCUR Δt/ΔT Δt/ΔV_{CC}	R_A = 1kΩ to 100kΩ C = 0.1μF	-	 2.25 150 0.3	 - 	 % ppm/°C %/V
Control Voltage	V_C	V_{CC} = 15V	9.0	10.0	11.0	V
		V_{CC} = 5V	2.6	3.33	4.0	V
Threshold Voltage	V_{TH}	V_{CC} = 15V	-	10.0	-	V
		V_{CC} = 5V	-	3.33	-	V
Threshold Current (Note3)	I_{TH}	-	-	0.1	0.25	μA
Trigger Voltage	V_{TR}	V_{CC} = 5V	1.1	1.67	2.2	V
		V_{CC} = 15V	4.5	5	5.6	V
Trigger Current	I_{TR}	V_{TR} = 0V		0.01	2.0	μA
Reset Voltage	V_{RST}	-	0.4	0.7	1.0	V
Reset Current	I_{RST}	-		0.1	0.4	mA
Low Output Voltage	V_{OL}	V_{CC} = 15V I_{SINK} = 10mA I_{SINK} = 50mA	-	 0.06 0.3	 0.25 0.75	 V V
		V_{CC} = 5V I_{SINK} = 5mA	-	0.05	0.35	V
High Output Voltage	V_{OH}	V_{CC} = 15V I_{SOURCE} = 200mA I_{SOURCE} = 100mA	 12.75	 12.5 13.3	 - 	 V V
		V_{CC} = 5V I_{SOURCE} = 100mA	2.75	3.3	-	V
Rise Time of Output (Note4)	t_R	-	-	100	-	ns
Fall Time of Output (Note4)	t_F	-	-	100	-	ns
Discharge Leakage Current	I_{LKG}	-	-	20	100	nA

Notes:

1. When the output is high, the supply current is typically 1mA less than at V_{CC} = 5V.
2. Tested at V_{CC} = 5.0V and V_{CC} = 15V.
3. This will determine the maximum value of R_A + R_B for 15V operation, the max. total R = 20MΩ, and for 5V operation, the max. total R = 6.7MΩ.
4. These parameters, although guaranteed, are not 100% tested in production.

LM555

Application Information

Table 1 below is the basic operating table of 555 timer:

Table 1. Basic Operating Table

Threshold Voltage (V_{th})(PIN 6)	Trigger Voltage (V_{tr})(PIN 2)	Reset(PIN 4)	Output(PIN 3)	Discharging Tr. (PIN 7)
Don't care	Don't care	Low	Low	ON
V_{th} > 2Vcc / 3	V_{th} > 2Vcc / 3	High	Low	ON
Vcc / 3 < V_{th} < 2 Vcc / 3	Vcc / 3 < V_{th} < 2 Vcc / 3	High	-	-
V_{th} < Vcc / 3	V_{th} < Vcc / 3	High	High	OFF

When the low signal input is applied to the reset terminal, the timer output remains low regardless of the threshold voltage or the trigger voltage. Only when the high signal is applied to the reset terminal, the timer's output changes according to threshold voltage and trigger voltage.

When the threshold voltage exceeds 2/3 of the supply voltage while the timer output is high, the timer's internal discharge Tr. turns on, lowering the threshold voltage to below 1/3 of the supply voltage. During this time, the timer output is maintained low. Later, if a low signal is applied to the trigger voltage so that it becomes 1/3 of the supply voltage, the timer's internal discharge Tr. turns off, increasing the threshold voltage and driving the timer output again at high.

1. Monostable Operation

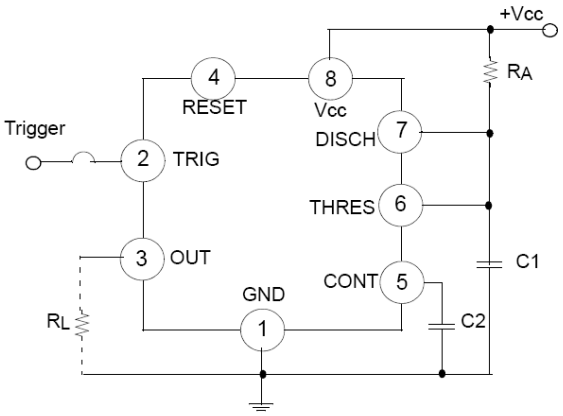


Figure 1. Monoatable Circuit

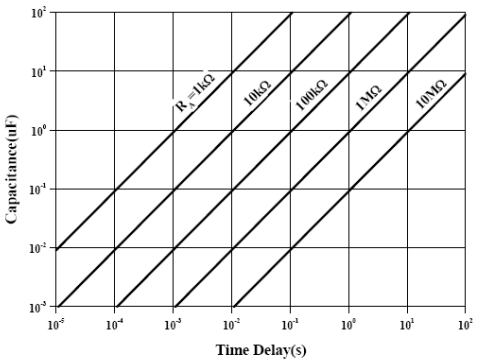


Figure 2. Resistance and Capacitance vs. Time delay(t_d)

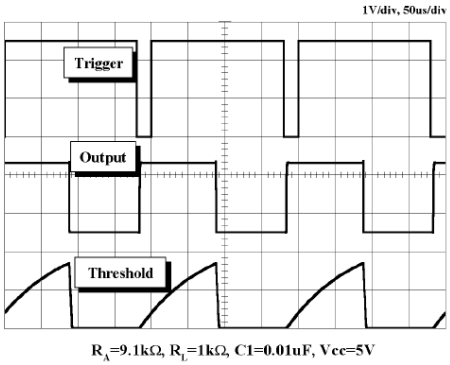


Figure 3. Waveforms of Monostable Operation

Figure 1 illustrates a monostable circuit. In this mode, the timer generates a fixed pulse whenever the trigger voltage falls below Vcc/3. When the trigger pulse voltage applied to the #2 pin falls below Vcc/3 while the timer output is low, the timer's internal flip-flop turns the discharging Tr. off and causes the timer output to become high by charging the external capacitor C1 and setting the flip-flop output at the same time.
The voltage across the external capacitor C1, V_{C1} increases exponentially with the time constant $t=R_A*C$ and reaches 2Vcc/3 at $td=1.1R_A*C$. Hence, capacitor C1 is charged through resistor R_A. The greater the time constant R_AC, the longer it takes for the V_{C1} to reach 2Vcc/3. In other words, the time constant R_AC controls the output pulse width.
When the applied voltage to the capacitor C1 reaches 2Vcc/3, the comparator on the trigger terminal resets the flip-flop, turning the discharging Tr. on. At this time, C1 begins to discharge and the timer output converts to low.
In this way, the timer operating in the monostable repeats the above process. Figure 2 shows the time constant relationship based on R_A and C. Figure 3 shows the general waveforms during the monostable operation.
It must be noted that, for a normal operation, the trigger pulse voltage needs to maintain a minimum of Vcc/3 before the timer output turns low. That is, although the output remains unaffected even if a different trigger pulse is applied while the output is high, it may be affected and the waveform does not operate properly if the trigger pulse voltage at the end of the output pulse remains at below Vcc/3. Figure 4 shows such a timer output abnormality.

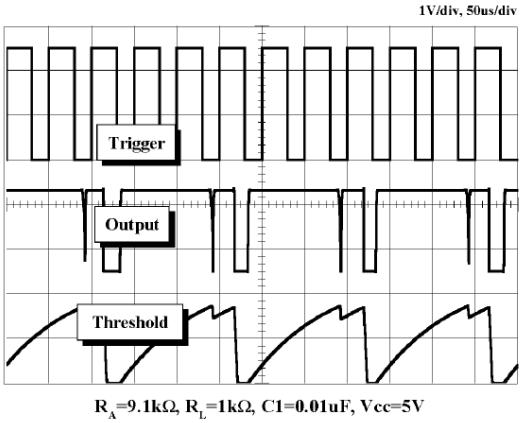


Figure 4. Waveforms of Monostable Operation (abnormal)

2. Astable Operation

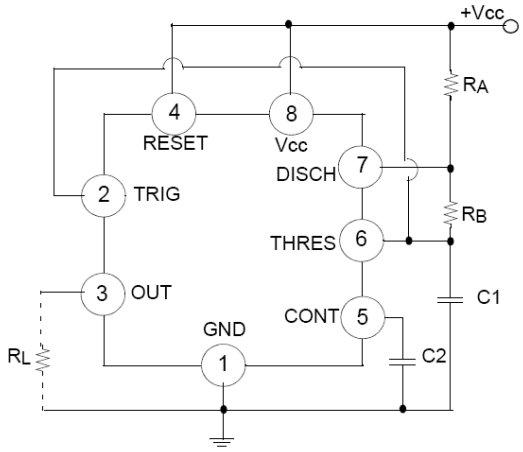


Figure 5. Astable Circuit

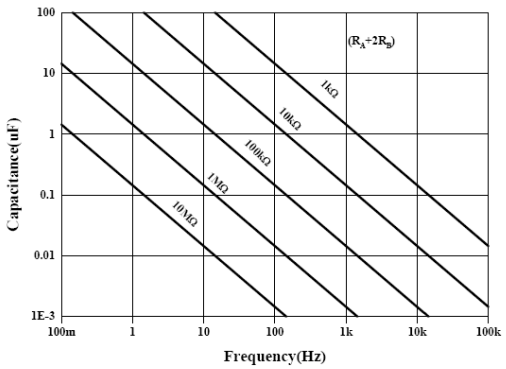


Figure 6. Capacitance and Resistance vs. Frequency

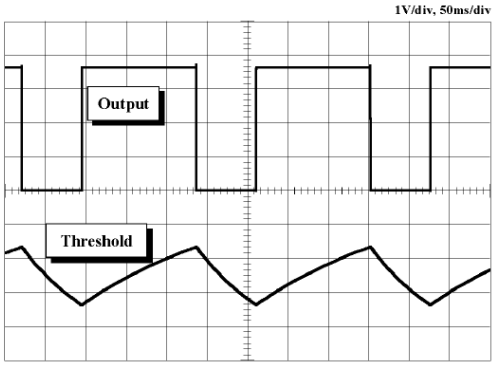
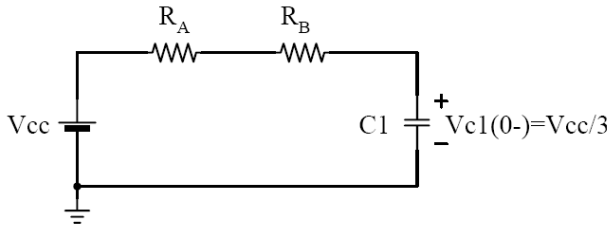


Figure 7. Waveforms of Astable Operation

An astable timer operation is achieved by adding resistor R_B to Figure 1 and configuring as shown on Figure 5. In the astable operation, the trigger terminal and the threshold terminal are connected so that a self-trigger is formed, operating as a multi vibrator. When the timer output is high, its internal discharging Tr. turns off and the V_{C1} increases by exponential function with the time constant $(R_A+R_B)*C$.
When the V_{C1}, or the threshold voltage, reaches 2Vcc/3, the comparator output on the trigger terminal becomes high, resetting the F/F and causing the timer output to become low. This in turn turns on the discharging Tr. and the C1 discharges through the discharging channel formed by R_B and the discharging Tr. When the V_{C1} falls below Vcc/3, the comparator output on the trigger terminal becomes high and the timer output becomes high again. The discharging Tr. turns off and the V_{C1} rises again.
In the above process, the section where the timer output is high is the time it takes for the V_{C1} to rise from Vcc/3 to 2Vcc/3, and the section where the timer output is low is the time it takes for the V_{C1} to drop from 2Vcc/3 to Vcc/3. When timer output is high, the equivalent circuit for charging capacitor C1 is as follows:



$$C_1\frac{dv_{c1}}{dt} = \frac{V_{cc} - V(0\text{-})}{R_A + R_B} \qquad (1)$$

$$V_{C1}(0+) = V_{CC}/3 \qquad (2)$$

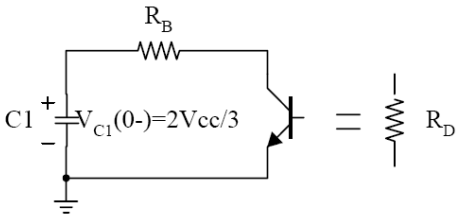
$$V_{C1}(t) = V_{CC}\left(1 - \frac{2}{3}e^{-\left(-\frac{t}{(R_A+R_B)C1}\right)}\right) \qquad (3)$$

Since the duration of the timer output high state(t_H) is the amount of time it takes for the $V_{C1}(t)$ to reach 2Vcc/3,

$$V_{C1}(t) = \frac{2}{3}V_{CC} = V_{CC}\left(1 - \frac{2}{3}e^{-\left(-\frac{t_H}{(R_A+R_B)C1}\right)}\right) \qquad (4)$$

$$t_H = C_1(R_A+R_B)\ln 2 = 0.693(R_A+R_B)C_1 \qquad (5)$$

The equivalent circuit for discharging capacitor C1, when timer output is low is, as follows:



$$C_1\frac{dv_{C1}}{dt} + \frac{1}{R_A+R_B}V_{C1} = 0 \qquad (6)$$

$$V_{C1}(t) = \frac{2}{3}V_{CC}e^{-\frac{t}{(R_A+R_D)C1}} \qquad (7)$$

Since the duration of the timer output low state(t_L) is the amount of time it takes for the $V_{C1}(t)$ to reach Vcc/3,

$$\frac{1}{3}V_{CC} = \frac{2}{3}V_{CC}e^{-\frac{t_L}{(R_A+R_D)C1}} \qquad (8)$$

$$t_L = C_1(R_B+R_D)\ln 2 = 0.693(R_B+R_D)C_1 \qquad (9)$$

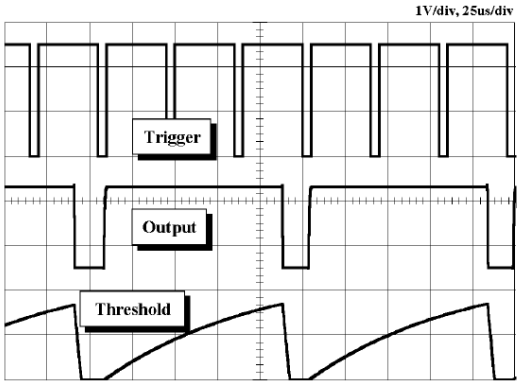
Since R_D is normally $R_B >> R_D$ although related to the size of discharging Tr.,
$t_L = 0.693R_BC_1$ (10)

Consequently, if the timer operates in astable, the period is the same with
'$T=t_H+t_L=0.693(RA+R_B)C_1+0.693R_BC_1=0.693(R_A+2R_B)C_1$' because the period is the sum of the charge time and discharge time. And since frequency is the reciprocal of the period, the following applies.

$$\text{frequency,} \qquad f = \frac{1}{T} = \frac{1.44}{(R_A+2R_B)C_1} \qquad (11)$$

3. Frequency divider

By adjusting the length of the timing cycle, the basic circuit of Figure 1 can be made to operate as a frequency divider. Figure 8. illustrates a divide-by-three circuit that makes use of the fact that retriggering cannot occur during the timing cycle.



R_A=9.1kΩ, R_L=1kΩ, C1=0.01uF, Vcc=5V

Figure 8. Waveforms of Frequency Divider Operation

4. Pulse Width Modulation

The timer output waveform may be changed by modulating the control voltage applied to the timer's pin 5 and changing the reference of the timer's internal comparators. Figure 9 illustrates the pulse width modulation circuit.
When the continuous trigger pulse train is applied in the monostable mode, the timer output width is modulated according to the signal applied to the control terminal. Sine wave as well as other waveforms may be applied as a signal to the control terminal. Figure 10 shows the example of pulse width modulation waveform.

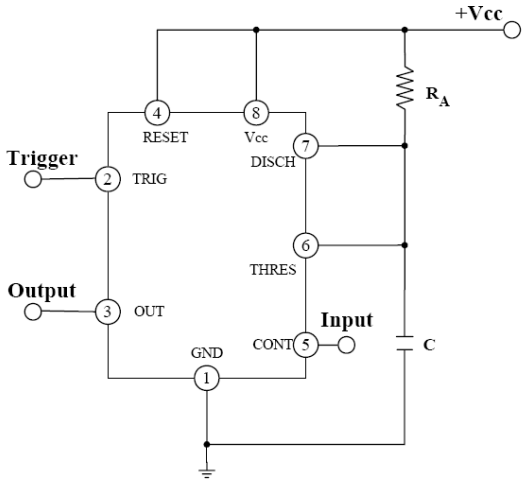
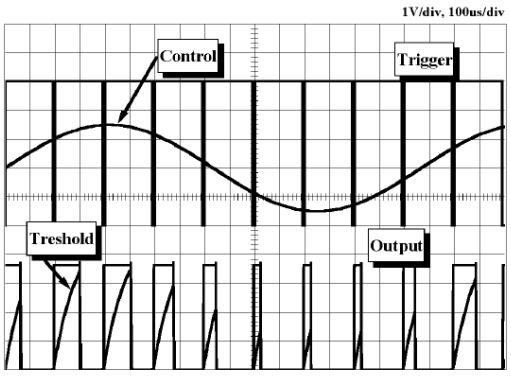


Figure 9. Circuit for Pulse Width Modulation



R_A=9.1kΩ, R_L=1kΩ, C1=0.01uF, Vcc=5V

Figure 10. Waveforms of Pulse Width Modulation

5. Pulse Position Modulation

If the modulating signal is applied to the control terminal while the timer is connected for the astable operation as in Figure 11, the timer becomes a pulse position modulator.
In the pulse position modulator, the reference of the timer's internal comparators is modulated which in turn modulates the timer output according to the modulation signal applied to the control terminal.
Figure 12 illustrates a sine wave for modulation signal and the resulting output pulse position modulation : however, any wave shape could be used.

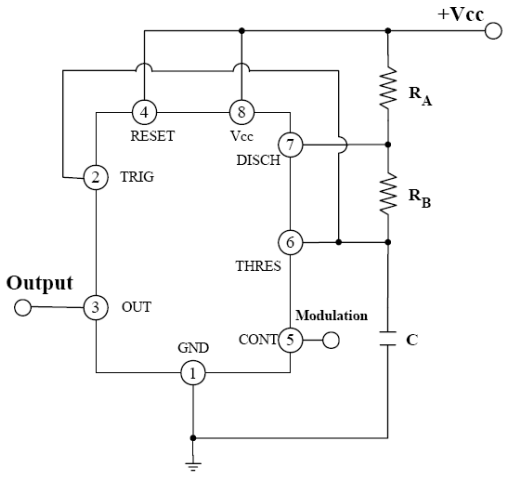


Figure 11. Circuit for Pulse Position Modulation

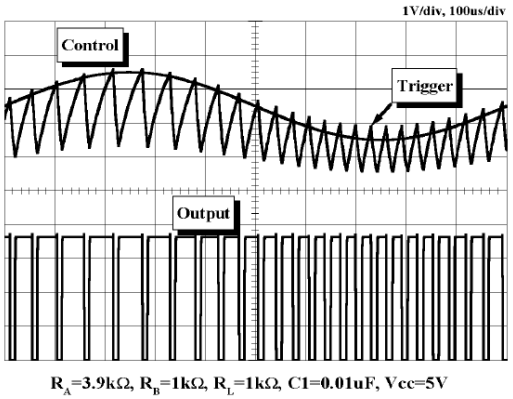


Figure 12. Waveforms of pulse position modulation

6. Linear Ramp

When the pull-up resistor RA in the monostable circuit shown in Figure 1 is replaced with constant current source, the V_{C1} increases linearly, generating a linear ramp. Figure 13 shows the linear ramp generating circuit and Figure 14 illustrates the generated linear ramp waveforms.

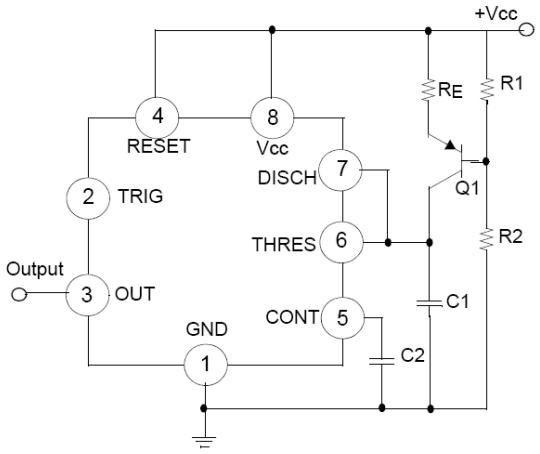


Figure 13. Circuit for Linear Ramp

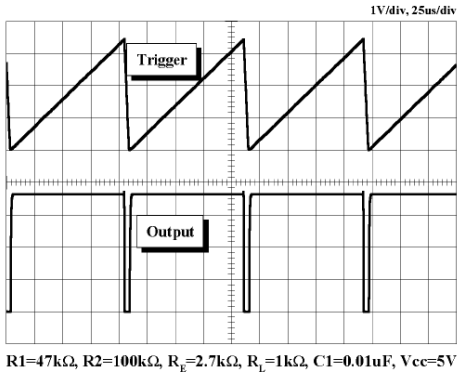


Figure 14. Waveforms of Linear Ramp

In Figure 13, current source is created by PNP transistor Q1 and resistor R1, R2, and R_E.

$$I_C = \frac{V_{CC} - V_E}{R_E} \qquad (12)$$

Here, V_E is

$$V_E = V_{BE} + \frac{R_2}{R_1 + R_2} V_{CC} \qquad (13)$$

For example, if Vcc=15V, R_E=20kΩ, R1=5kW, R2=10kΩ, and V_{BE}=0.7V,
V_E=0.7V+10V=10.7V
Ic=(15-10.7)/20k=0.215mA

LM555

When the trigger starts in a timer configured as shown in Figure 13, the current flowing through capacitor C1 becomes a constant current generated by PNP transistor and resistors.
Hence, the V_C is a linear ramp function as shown in Figure 14. The gradient S of the linear ramp function is defined as follows:

$$S = \frac{V_{p-p}}{T} \qquad (14)$$

Here the Vp-p is the peak-to-peak voltage.
If the electric charge amount accumulated in the capacitor is divided by the capacitance, the V_C comes out as follows:

$$V=Q/C \qquad (15)$$

The above equation divided on both sides by T gives us

$$\frac{V}{T} = \frac{Q/T}{C} \qquad (16)$$

and may be simplified into the following equation.

$$S=I/C \qquad (17)$$

In other words, the gradient of the linear ramp function appearing across the capacitor can be obtained by using the constant current flowing through the capacitor.
If the constant current flow through the capacitor is 0.215mA and the capacitance is 0.02μF, the gradient of the ramp function at both ends of the capacitor is S = 0.215m/0.022μ = 9.77V/ms.